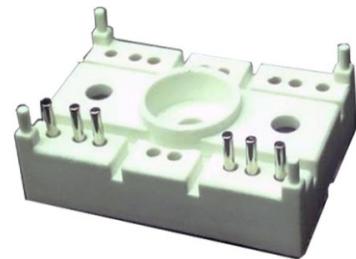


Anti-parallel Thyristor Module, 100A (Low Profile Package)

FEATURES

- High voltage
- 3000V_{RMS} isolating voltage
- High surge capability
- **Planar SCR chips**
- Heat transfer and isolation through direct copper bonded aluminum oxide ceramic (Al_2O_3 DBC)
- Simple mounting (One screw mounting)
- Compliant to RoHS
- Designed and qualified for multiple level

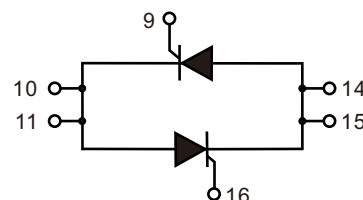


Low profile package

APPLICATIONS

- Soft starters
- Battery charges
- Light control
- Power converters
- Heat and temperature control

"KQ" Circuit Configuration :



PRODUCT SUMMARY

$I_{T(\text{RMS})}$	100A
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MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNIT
$I_{T(\text{RMS})}$	85°C	100	A
I_{TSM}/I_{FSM}	50 Hz	1500	
	60 Hz	1576	
I^2t	50 Hz	11.25	kA^2s
	60 Hz	10.31	
$I^2\sqrt{t}$		112.5	$\text{kA}^2\sqrt{\text{s}}$
V_{DRM}/V_{RRM}	Range	800 to 1600	V
T_J	Range	-40 to 150	°C

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS				
TYPE NUMBER	VOLTAGE CODE	V_{RRM}/V_{DRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V_{RSM}/V_{DSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM}/I_{DRM} AT 125°C mA
NK100KQ	08	800	900	15
	12	1200	1300	
	16	1600	1700	

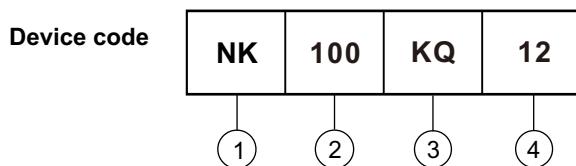
FORWARD CONDUCTION								
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNIT		
Maximum RMS on-state current	$I_{T(RMS)}$	180° conduction, half sine wave, 50Hz, $T_C = 85^\circ C$			100	A		
Maximum peak, one-cycle, on-state non-repetitive surge current	I_{TSM}	$t = 10ms$	No voltage reapplied	Sine half wave, initial $T_J = T_J$ maximum	1500			
		$t = 8.3ms$			1576			
Maximum I^2t for fusing	I^2t	$t = 10ms$	100% V_{RRM} reapplied	Sine half wave, initial $T_J = T_J$ maximum	11.25	kA^2s		
		$t = 8.3ms$			10.31			
		$t = 10ms$			7.8			
		$t = 8.3ms$			7.2			
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1$ to 10 ms, no voltage reapplied			112.5	$kA^2\sqrt{s}$		
Maximum on-state voltage drop	V_{TM}	$I_{TM} = 200A$, $T_J = 25^\circ C$, 180° conduction			1.8	V		
Maximum holding current	I_H	Anode supply = 6V, resistive load, $T_J = 25^\circ C$			150	mA		
Maximum latching current	I_L				400			

BLOCKING						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNIT
Maximum peak reverse and off-state leakage current	I_{RRM} I_{DRM}	$T_J = 125^\circ C$			15	mA
RMS isolation Voltage	V_{ISO}	50 Hz, circuit to base, all terminals shorted			2500 (1 min) 3000 (1 s)	V
Critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, exponential to 67% rated V_{DRM}			1000	V/ μ s

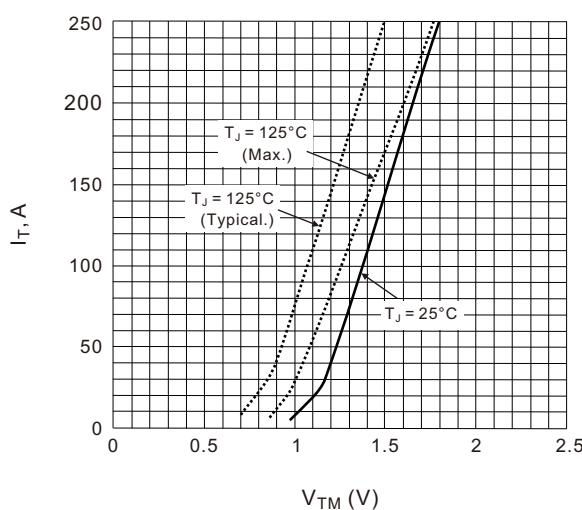
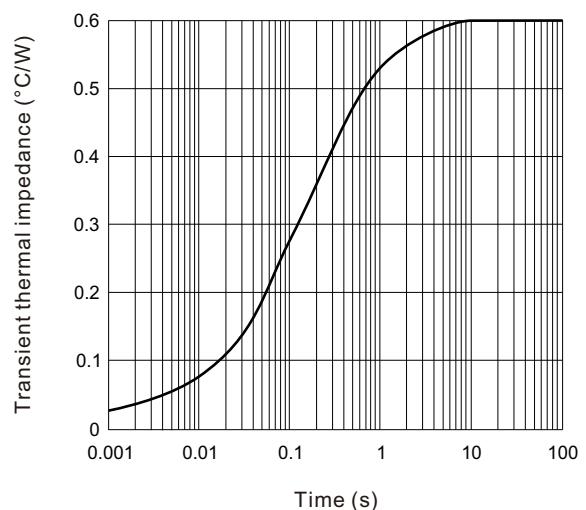
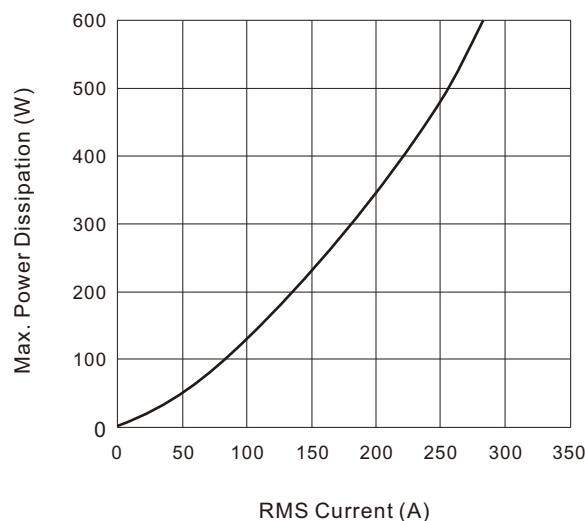
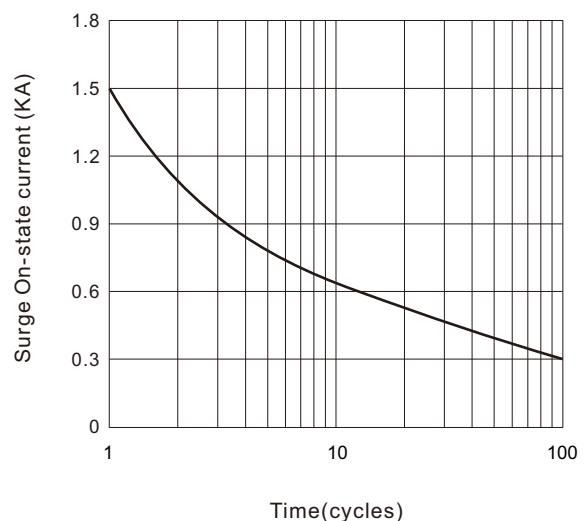
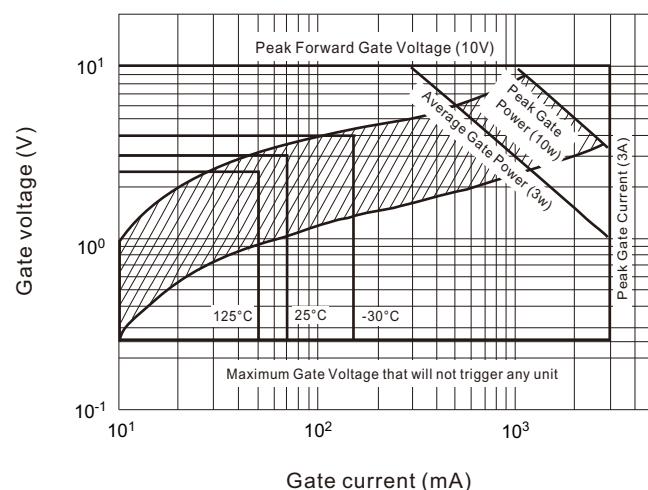
TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNIT		
Maximum peak gate power	P_{GM}	$t_p \leq 5$ ms, $T_J = T_J$ maximum			10	W		
Maximum average gate power	$P_{G(AV)}$	$f = 50$ Hz, $T_J = T_J$ maximum			3			
Maximum peak gate current	I_{GM}	$t_p \leq 5$ ms, $T_J = T_J$ maximum			3	A		
Maximum peak negative gate voltage	$-V_{GT}$				10	V		
Maximum required DC gate voltage to trigger	V_{GT}	$T_J = 25^\circ C$	Anode supply = 6V, resistive load; $R_a = 1\Omega$		0.7 to 1.5			
Maximum required DC gate current to trigger	I_{GT}				20 to 100	mA		
Maximum gate voltage that will not trigger	V_{GD}	$T_J = T_J$ maximum, 66.7% V_{DRM} applied			0.25	V		
Maximum gate current that will not trigger	I_{GD}				10	mA		
Maximum rate of rise of turned-on current	dl/dt	$T_J = 25^\circ C$, $I_{GM} = 1.5A$, $t_r \leq 0.5$ μ s			150	A/ μ s		

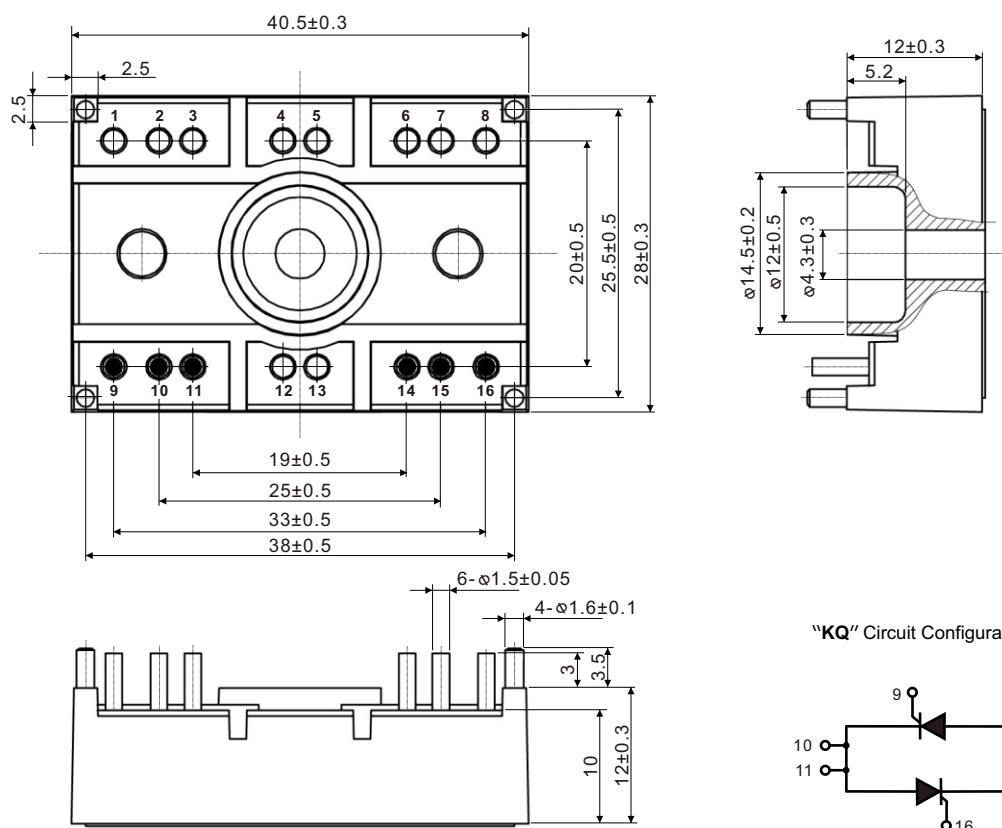
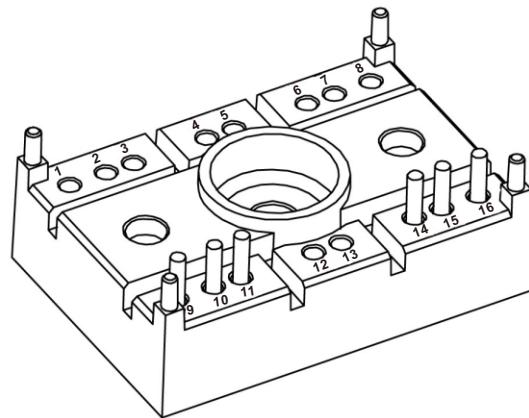
THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT
Maximum junction operating temperature range	T_J		-40 to 150	$^{\circ}\text{C}$
Maximum storage temperature range	T_{stg}		-40 to 150	
Maximum thermal resistance, junction to case per junction	R_{thJC}	DC operation	0.6	$^{\circ}\text{C/W}$
Maximum thermal resistance, case to heatsink per module	R_{thCS}	Mounting surface, smooth, flat and greased	0.18	
Mounting torque, $\pm 10\%$ module to heatsink, M4		A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads.	2	$\text{N}\cdot\text{m}$
Approximate weight			22	g
			0.78	oz.
Case style			Low Profile package (Nell-Top 2)	

Ordering Information Table



- [1]** - Nell's Low profile module (Nell-Top 2)
- [2]** - Current rating : $I_T(\text{RMS})$
- [3]** - Circuit configuration type
- [4]** - Voltage code x 100 = $V_{\text{DRM}}/V_{\text{RRM}}$

Fig.1 On-state Voltage characteristics (per thyristor)

Fig.2 Transient thermal Impedance vs. time (per thyristor)

Fig.3 Power Dissipation Vs. RMS Current

Fig.4 Surge On-state Current Vs. Cycles

Fig.5 Gate characteristics




All dimensions in millimeters(inches)